

WSD4046DN33

N-Channel MOSFET

General Description

The WSD4046DN33 is the highest performance trench N-Channel MOSFETs with extreme high cell density , which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The WSD4046DN33 meet the RoHS and Green Product requirement, 100% E_{AS} guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% E_{AS} Guaranteed
- Green Device Available

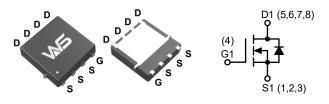
Product Summery

BV _{DSS}	R _{DS(ON)}	I _D
40V	8.0mΩ	45A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter
- DC-DC Power System
- Power Tool Application

DFN3X3-8L Pin Configuration



Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	40	V	
V _{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V	45		
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V	28	A	
I _{DM}	Pulsed Drain Current ^a	60		
E _{AS}	Single Pulse Avalanche Energy ^b	25	mJ	
I _{AS}	Avalanche Current	10	А	
P _D @T _C =25°C	Total Power Dissipation	26	W	
T _{STG}	Storage Temperature Range -55 to 1		°C	
TJ	Operating Junction Temperature Range	-55 to 150		

Thermal Data

Symbol	Parameter	Тур.	Max.	Units	
R _{θJA}	Thermal Resistance, Junction-to-Ambient ¹		60	°C/M	
R _{θJC}	Thermal Resistance, Junction-to-Case ¹		4.7	°C/W	

Note a: Package is limited to 60A.

Note b: UIS tested and pulse width limited by maximum junction temperature 150° C (initial temperature $T_J=25^{\circ}$ C).

Absolute Maximum Ratings



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Electrical Characteristics (T_J=25°C, Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage V_{GS} =0V , I _D =250µA		40			V
$\Delta BV_{DSS}/\Delta T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C, I _D =1mA		0.043		V/°C
D	Statia Dasia Source On Desistance 2	V _{GS} =10V , I _D =10A		8.0	11	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =5A		10	14	- mΩ
V _{GS(th)}	Gate Threshold Voltage		1.2	1.6	2.5	V
$\Delta V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	- V _{GS} =V _{DS} , Ι _D =250μΑ		-6.94		mV/°C
		V _{DS} =32V , V _{GS} =0V , T _J =25°C			2.0	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =32V , V _{GS} =0V , T _J =55°C			10	μA
I _{GSS}	Gate-Source Leakage Current	Gate-Source Leakage Current V _{GS} =±20V , V _{DS} =0V			±100	nA
9 _{fs}	Forward Transconductance	V _{DS} =5V , I _D =10A		22		S
R _g	Gate Resistance $V_{DS}=0V$, $V_{GS}=0V$, f = 1.0MHz			1.7		Ω
Qg	Total Gate Charge (10V)			38		
Q _{gs}	Gate-Source Charge	V _{DS} =20V , V _{GS} =10V , I _D =10A		7		nC
Q _{gd}	Gate-Drain Charge			8		
T _{d(on)}	Turn-On Delay Time			12		
Tr	$\label{eq:constraint} \begin{array}{c} \mbox{Rise Time} & $V_{DD}\mbox{=}20V, \ V_{GEN}\mbox{=}10V,$ \\ \mbox{Turn-Off Delay Time} & $R_G\mbox{=}1\Omega, \ I_{DS}\mbox{=}1A, \ R_L\mbox{=}15\Omega \end{array}$			12		
T _{d(off)}				39		ns
T _f	Fall Time			10		
C _{iss}	Input Capacitance			2450		
C _{oss}	Output Capacitance $V_{DS}=20V$, $V_{GS}=0V$, f = 1.0MHz			185		pF
C _{rss}	Reverse Transfer Capacitance			170		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
ا _S	Continuous Source Current ^{1,6}	(-1)			20	А
I _{SM}	Pulsed Source Curren ^{2,6}	$V_G = V_D = 0V$, Force Current			56	А
V _{SD}	Diode Forward Voltage ²	V_{GS} =0V , I _S =10A , T _J =25°C			1.3	V

Note:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t<10sec.

2. The data tested by pulsed , pulse width $\leq 300 \mu s$, duty cycle $\leq 2\%$

3. The $\,E_{AS}\,$ data shows Max. rating . The test condition is $\,V_{DD}$ =20V, V_{GS} =10V, L=0.5mH, I_{AS} =10A

4. The power dissipation is limited by 150°C junction temperature.

5. The Min. value is 100% $\, E_{AS} \,$ tested guarantee.

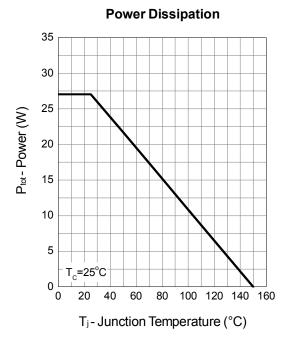
6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

7. Package limitation current is 60A.

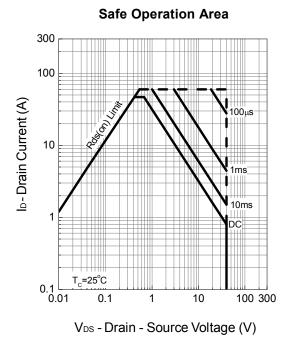




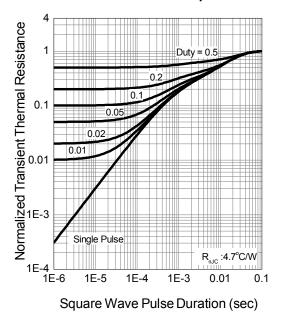
Typical Characteristics



Drain Current 50 40 Ip-Drain Current (A) 30 20 10 Τ. C.V_=10V =25 0 80 0 20 40 60 100 120 140 160 T_j-Junction Temperature (°C)



Thermal Transient Impedance

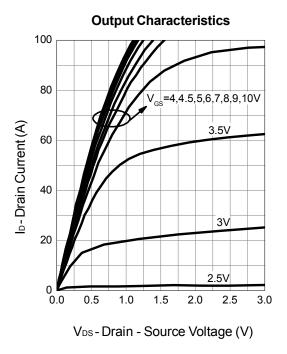


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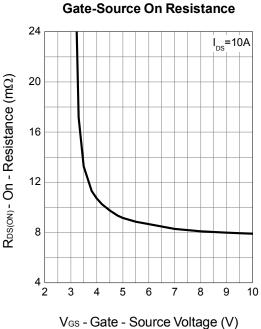
Typical Characteristics (Cont.)



Drain-Source On Resistance 14 12 $R_{DS(ON)}$ - On - Resistance (m Ω) V_{GS}=4.5V 10 V_{GS}=10V 8 6 4 ∟ 0 10 20 30 40 50 60

ID-Drain Current (A)

Gate Threshold Voltage

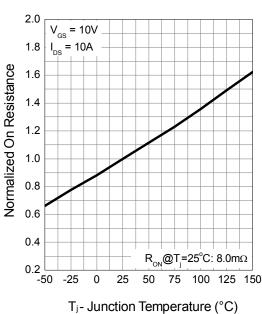


1.6

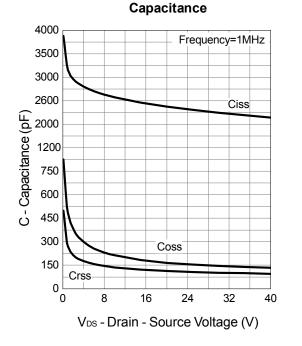
I_{DS} =250μA 1.4 Normalized Threshold Vlotage 1.2 1.0 0.8 0.6 0.4 0.2 └─ -50 -25 0 50 75 100 125 150 25 T_j - Junction Temperature (°C)



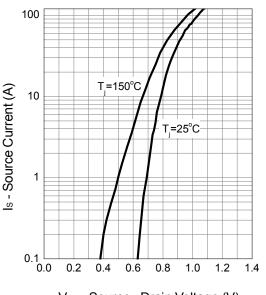
Typical Characteristics (Cont.)



Drain-Source On Resistance

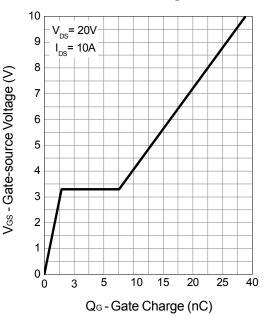


Source-Drain Diode Forward



Vsd - Source - Drain Voltage (V)

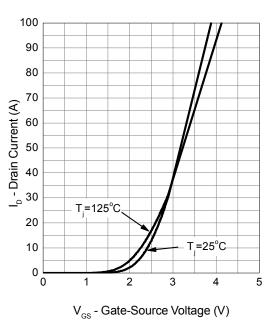
Gate Charge







Typical Characteristics (Cont.)



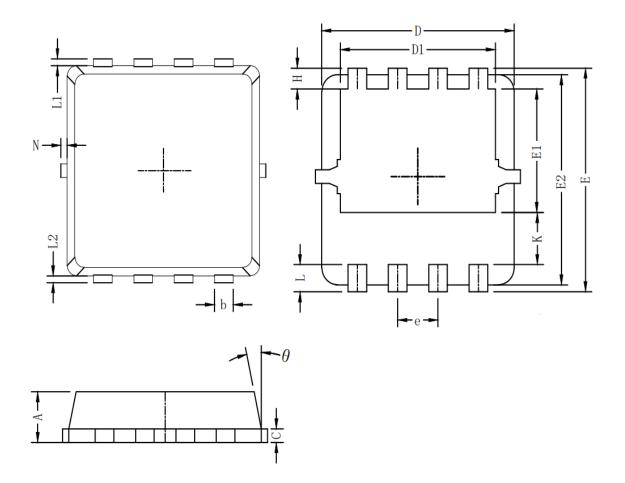
Transfer Characteristics



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Packaging information



Symbol	Dim in mm				
	min	typ	max		
А	0.6	0.75	0.9		
b	0.2	0.3	0.4		
С	0.15	0.2	0.25		
D	3	3.1	3.2		
D1	2.3	2.45	2.6		
E	3.15	3.3	3.45		
E1	1.43	1.73	1.93		
E2	2.9	3.05	3.2		
е	0.65BSC				
Н	0.2	0.35	0.5		
К	0.57	0.77	0.87		
L	0.3	0.4	0.5		
L1/L2	0.1REF				
θ	8°	10°	13°		
Ν	0		0.15		



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